

**SIEMENS**

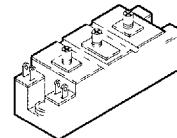
SIEMENS AKTIENGESELLSCHAFT

T-23-09

**IGBT Module**  
Preliminary Data

**BSM 50 GB 100 D**  
**BSM 50 GAL 100 D**
 $V_{CE} = 1000 \text{ V}$  $I_C = 2 \times 70 \text{ A at } T_C = 25 \text{ }^\circ\text{C}$  $I_C = 2 \times 50 \text{ A at } T_C = 80 \text{ }^\circ\text{C}$ 

- Power module
- Half-bridge/Chopper
- Including fast free-wheel diodes
- Package with insulated metal base plate
- Package outlines/Circuit diagram: 2b, 2c<sup>1)</sup>



VM205170

Half-bridge		Chopper	
Type	Ordering Code	Type	Ordering code
BSM 50 GB 100 D	C67076-A2100-A2	BSM 50 GAL 100 D	C67076-A2002-A2

**Maximum Ratings**

Parameter	Symbol	Values	Unit
Collector-emitter voltage	$V_{CE}$	1000	V
Collector-gate voltage, $R_{GE} = 20 \text{ k}\Omega$	$V_{CGR}$	1000	
Gate-emitter voltage	$V_{GE}$	$\pm 20$	
Continuous collector current, $T_C = 25 \text{ }^\circ\text{C}$ $T_C = 80 \text{ }^\circ\text{C}$	$I_C$	70 50	A
Pulsed collector current, $T_C = 25 \text{ }^\circ\text{C}$ $T_C = 80 \text{ }^\circ\text{C}$	$I_{C \text{ puls}}$	140 100	
Operating and storage temperature range	$T_J, T_{stg}$	- 55 ... + 150	$^\circ\text{C}$
Power dissipation, $T_C = 25 \text{ }^\circ\text{C}$	$P_{tot}$	500	W
Thermal resistance, chip-case	$R_{thJC}$	$\leq 0.25$	K/W
Insulation test voltage <sup>2)</sup> , $t = 1 \text{ min.}$	$V_{is}$	2500	$V_{ac}$
Creepage distance	-	16	mm
Clearance	-	11	
DIN humidity category, DIN 40 040	-	F	-
IEC climatic category, DIN IEC 68-1	-	55/150/56	

<sup>1)</sup> See chapter Package Outline and Circuit Diagrams.<sup>2)</sup> Insulation test voltage between collector and metal base plate referred to standard climate 23/50 in acc. with DIN 50 014, IEC 146, para. 492.1

**SIEMENS****BSM 50 GB 100 D****BSM 50 GAL 100 D****SIEMENS AKTIENGESELLSCHAFT****Electrical Characteristics**at  $T_J = 25^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Static Characteristics**

Collector-emitter breakdown voltage $V_{GE} = 0$ , $I_C = 1 \text{ mA}$	$V_{(BR)CES}$	1000	—	—	V
Gate threshold voltage $V_{GE} = V_{CE}$ , $I_C = 4 \text{ mA}$	$V_{GE(\text{th})}$	4.8	5.5	6.2	
Collector-emitter saturation voltage $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $T_J = 25^\circ\text{C}$ $T_J = 150^\circ\text{C}$	$V_{CE(\text{sat})}$	—	2.8	3.3	
Zero gate voltage collector current $V_{CE} = 1000 \text{ V}$ , $V_{GE} = 0$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$	$I_{CES}$	—	—	1000 4000	$\mu\text{A}$
Gate-emitter leakage current $V_{GE} = 20 \text{ V}$ , $V_{CE} = 0$	$I_{GES}$	—	—	100	nA

**AC Characteristics**

Forward transconductance $V_{CE} = 20 \text{ V}$ , $I_C = 50 \text{ A}$	$g_{ts}$	18	—	—	S
Input capacitance $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0$ , $f = 1 \text{ MHz}$	$C_{iss}$	—	8000	—	pF
Output capacitance, $V_{GS} = 0$ $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0$ , $f = 1 \text{ MHz}$	$C_{oss}$	—	640	—	
Reverse transfer capacitance $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0$ , $f = 1 \text{ MHz}$	$C_{rss}$	—	250	—	

**SIEMENS****BSM 50 GB 100 D****BSM 50 GAL 100 D****SIEMENS AKTIENGESELLSCHAFT****Switching Characteristics**at  $T_j = 125^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Resistive Load**

Turn-on delay time $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$t_{d(on)}$	20	30	40	ns
Rise time $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$t_r$	—	140	—	
Turn-off delay time $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$t_{d(off)}$	—	300	—	
Fall time $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$t_f$	—	300	—	

**Inductive Load**

Turn-on delay time $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$t_{d(on)}$	20	30	40	ns
Rise time $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$t_r$	10	20	25	
Turn-off delay time $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$t_{d(off)}$	220	300	360	
Fall time $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$t_f$	25	35	45	
Turn-off loss ( $E_{off} = E_{off1} + E_{off2}$ ) $V_{CC} = 600 \text{ V}$ , $V_{GE} = 15 \text{ V}$ , $I_C = 50 \text{ A}$ $R_{g(on)} = 3.3 \Omega$ , $R_{g(off)} = 3.3 \Omega$	$E_{off1}$ $E_{off2}$	— —	2.0 2.0	— —	mWs

**SIEMENS****BSM 50 GB 100 D  
BSM 50 GAL 100 D****SIEMENS AKTIENGESELLSCHAFT****Electrical Characteristics**at  $T_j = 25^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Free-Wheel Diode**

Diode forward voltage $I_F = 50 \text{ A}$ , $V_{GE} = 0$ $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	$V_F$	—	1.85 1.45	—	V
Reverse recovery time $I_F = 50 \text{ A}$ , $V_R = 600 \text{ V}$ $V_{GE} = 0$ , $di_F/dt = -800 \text{ A}/\mu\text{s}$ $T_j = 125^\circ\text{C}$	$t_{rr}$	—	0.2	—	$\mu\text{s}$
Reverse recovery charge $I_F = 50 \text{ A}$ , $V_R = 600 \text{ V}$ $V_{GE} = 0$ , $di_F/dt = -800 \text{ A}/\mu\text{s}$ $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	$Q_{rr}$	—	3.6 10	—	$\mu\text{C}$
Soft factor $I_F = 50 \text{ A}$ , $V_R = 600 \text{ V}$ $V_{GE} = 0$ , $di_F/dt = -800 \text{ A}/\mu\text{s}$ $T_j = 125^\circ\text{C}$	$S$	—	1	—	—
Thermal resistance Chip-case	$R_{thJC}$	—	—	0.9	K/W